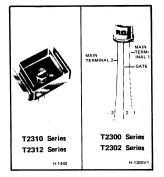


T2300 T2302 T2310 T2312 Series



2.5-A Sensitive-Gate Silicon Triacs

For Low-Power Phase-Control and Load-Switching Applications *Features:*

- Very High Gate Sensitivity
- 3 mA max. for T2300 and T2310 series 10 mA max. for T2302 and T2312 series
- 3-Lead Package for Printed Circuit Board Applications

Thyristors

Shorted Emitter Design

Voltage	100 V	200 V	400 V						
Package	Types	Types	Types						
Mod. TO-5	T2300A (40525)	T2300B (40526)	T2300D (40527)						
Mod, TO-5	T2302A (40528)	T2302B (40529)	T2302D (40530)						
TO-5 with Radiator	T2310A (40531)	T2310B (40532)	T2310D (40533)						
TO-5 with Radiator	T2312A (40534)	T2312B (40535)	T2312D (40536)						
Numbers in parentheses are former RCA type numbers.									

RCA T2300-, T2302-, T2310-, and T2312-series triacs are gate-controlled full-wave ac silicon switches. They are designed to switch from a blocking state to a conducting state for either polarity of applied voltage with positive or negative gate triggering.

The T2302 series has higher dv/dt capability and higher gate trigger current requirements than the T2300 series. The gate sensitivity of these triacs permits the use of economical transistorized and IC control circuits and enhances their use in low-power phase control and load-switching applications.

The T2300 series has rms on-state current ratings of 2.5 amperes at a case temperature of $+60^{\circ}$ C while the T2302 series has the same ratings at a case temperature of $+70^{\circ}$ C.

The repetitive peak off-state voltage rating for T2300A and T2302A is 100 volts; for T2300B and T2302B, 200 volts; and for T2300D and T2302D, 400 volts.

The T2310 and T2312 series are the same as the T2300 and T2302 series, respectively, but have factory-attached heatradiators and are intended for printed-circuit-board applications.

MAXIMUM RATINGS, Absolute-Maximum Values:

For Operation with 50/60-Hz, Sinuosidal Supply Voltage and Resistive or Inductive Load

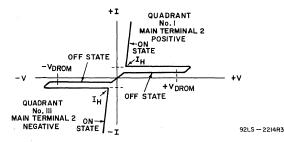
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REPETITIVE PEAK OFF-STATE VOLTAGE (Gate Open):	VDROM		
T ₁ = -40°C to +90°C: T2300A, T2310A		100	v
T2300B, T2310B		200	v
T2300D, T2310D		400	v
T ₁ = -40°C to +100°C: T2302A, T2312A		100	v
T2302B, T2312B		200	v
T2302D, T2312D		400	v
RMS ON-STATE CURRENT (Conduction Angle = 360°):	IT (RMS)		
Tc = 60°C: T2300 series		2.5	А
T _C = 70°C: T2302 series		2.5	А
T _A = 25°C: T2300 series		0.35	А
T2302 series		0.40	А
For other conditions		See Figs. 2	, 3, 4 & 5
For heat-radiator types		See F	igs. 6 & 7
PEAK SURGE (NON-REPETITIVE) ON-STATE CURRENT:	TSM		
For one full cycle of applied principal voltage, $T_{\rm C}$ as above			
60 Hz sinusoidal		25	А
50 Hz sinusoidal		21	А
For more than one full cycle of applied voltage		:	See Fig. 8
RATE OF CHANGE OF ON-STATE CURRENT:			
VDM = VDROM, IGT = 50 mA, t _r = 0.1 µs (See Fig. 19)	di/dt	100	A/μs
FUSING CUBBENT (for Triac Protection):			
$T_{\rm J} = -65$ to 100°C, t = 1.25 to 10 ms	l ² t	3	A2s

MAXIMUM RATINGS (Cont'd.).

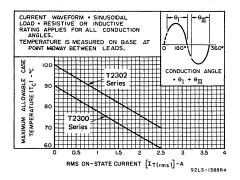
PEAK GATE-TRIGGER CURRENT ⁺ : For 1 μs max	IGTM	0.5	А
GATE POWER DISSIPATION*: Peak (For 1 μs max.) Average: TC = 60°C TA = 25°C	PGM PG (AV)	10 0.15 0.05	W W W
TEMPERATURE RANGE [‡] : Storage Operating (case): T2300 Series T2302 Series T2310, T2312 Series (From -40°C) Upper limits		-40 to +150 -40 to +90 -40 to +100 See Figs. 6	0C 00
LEAD TEMPERATURE: During soldering, terminal temperature at a distance ≥ 1/6 in. (1.58 mm) from the case for 10 s		225	٥C

For either polarity of main terminal 2 voltage (VMT2) with reference to main terminal 1.

- with reference to main terminal 1.
- † For either polarity of gate voltage (VG) ‡ For information on the reference point of temperature measurement see Dimensional Outlines.







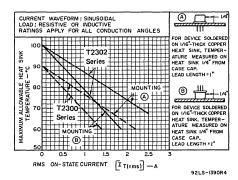


Fig. 2 --Conduction rating chart (case temperature) for T2300 and T2302 series.

Fig. 3 - Conduction characteristics as a function of mounting method for T2300 and T2302 series.

ELECTRICAL CHARACTERISTICS

LIMITS								
	SYMBOL	Т2	T2300 Series			T2302 Series		
CHARACTERISTIC		T2310 Series			T2312 Series			UNITS
		MIN. TYP. MAX		MIN. TYP. MAX				
Peak Off-State Current:								
Gate Open and VDROM = Max. rated value								
At T _i = +100° C	IDROM	-	-	-	-	0.2	0.75	mA
At $T_j = +90^{\circ} C$			0.2	0.75	-	-	-	
Maximum On-State Voltage:	VTM							
For $i_T = 10 A$ (peak) and $T_C = 25^{\circ} C$		-	1.7	2.2	-	1.7	2.2	V
DC Holding Current:				l				
Gate Open, Initial principal current = 150 mA (DC), V _D =12	1.						4.5	
At $T_C = 25^{\circ} C$	Чно	- 2		5	1	l 6.5- e Fig.		mA
For other case temperatures		See Fig. 14				e rig.	15 T	
Critical Rate of Rise of Commutation Voltage:								
For $V_D = V_{DROM}$, $I_T(RMS) = 2.5 A$, commutating	dv/dt							
di/dt = 0.95 A/µs, gate unenergized, (See Fig. 20), Tc = 100°C	uv/ut	_						V/μ
$T_{\rm C} = 90^{\circ}{\rm C}$	1	0.5	-		0.5	-	-	V/μ
Critical Rate-of-Rise of Off-State Voltage:								
For $V_D = V_{DROM}$, exponential voltage rise,	dv/dt					1		
and gate open At T _C = +100 ^o C				Į	6	10		V/μs
At $T_C = +90^{\circ} C$		-3	5	_	-			Į
DC Gate-Trigger Current:	†	<u> </u>	<u> </u>					
		-	1	3	-	3.5	10	
$R_L = 30 \Omega$, and 111^{-1} negative negative	IGT	-	1	3	-	3.5	10	mA
$T_{C} = 250 C$ 1 positive negative		-	2	3	-	7	10	
111 ⁺ negative positive		-	2 Fig. 12	3	-	7 • Fig. '	10	
For other case temperatures		See	-ig. 12		See	s = ig. T	13 T	
DC Gate-Trigger Voltage:								
At $T_C = 25^{\circ} C$	VGT		1	2.2	_	1	2.2	
For other case temperatures		Se	e Fig. 1		Se	See Fig.	•	v V
For vD = VDROM and RL = 125 Ω			l J	I I		1	1	
$At T_{C} = 100^{\circ} C$		-	-	-	0.15	-	-	1
At $T_C = +90^{\circ} C$		0.15	-	-	1-	<u> </u>	-	
Thermal Resistance, Junction-to-Case:					Ι.			
Steady-State	^R θJC	8.5 (max.)			8.5 (max.)			•c <i>N</i>
	1	(T2300 series) (T2302 series)				eries)		

For either polarity of main terminal 2 voltage (VMT2) with reference to main terminal 1.

For either polarity of gate voltage (V_G) with reference to main terminal 1.

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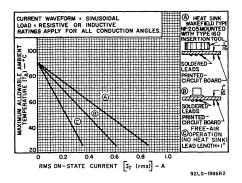


Fig. 4 – Conduction rating chart (ambient temperature) for T2300 series.

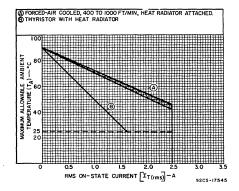


Fig. 6 – Conduction rating chart (ambient temperature) for T2310 series.

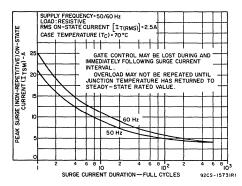


Fig. 8 – Peak surge on-state current vs. surge-current duration for all types.

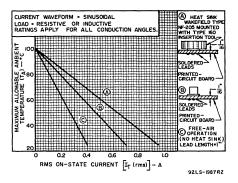


Fig. 5 – Conduction rating chart (ambient temperature) for T2302 series.

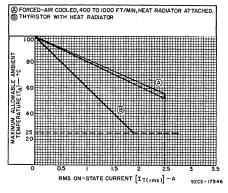


Fig. 7 – Conduction rating chart (ambient temperature) for T2312 series.

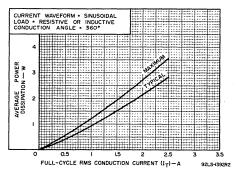


Fig. 9 - Power dissipation curves for all types.

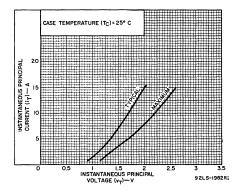
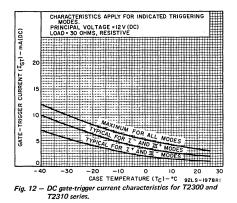
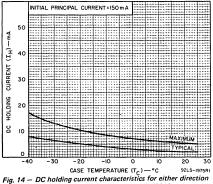


Fig. 10 – On-state characteristics for either direction of principal current for all types.





of principal current for T2300 and T2310 series.

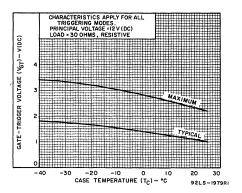
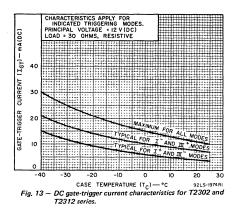
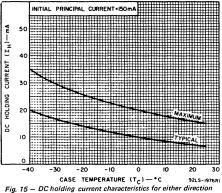


Fig. 11 - DC Gate-trigger voltage characteristics for all types.





of prinicpal current for T2302 and T2312 series.

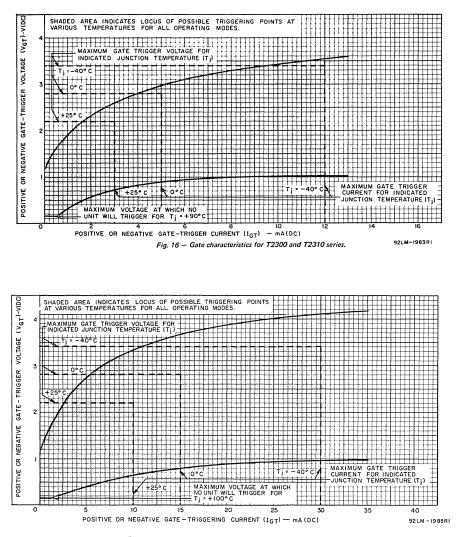


Fig. 17 - Gate characteristics for T2302 and T2312 series.

TERMINAL CONNECTIONS

For T2300 and T2302 series

For T2310 and T2312 series

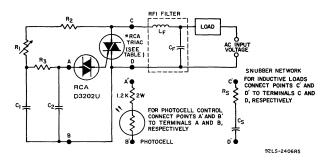
Lead No. 1 – Main terminal 1 Lead No. 2 – Gate Case, Lead No. 3 – Main terminal 2 Lead No. 1 — Main terminal 1 Lead No. 2 — Gate Heat Rad., Lead No. 3 — Main terminal 2

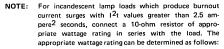
AC INPUT VOLTAGE 1201/

60Hz

240V

60Hz





Power Rating of

%W

½₩

15KΩ 200µH 0.1µF 0.075µF

	10-ohm Resistor = 10 x (rms load current) ²										
	C1	C2	R ₁	R ₂	R3	RFI FIL LF *	TER CF*	SNUB		RCA TYPES	
E				_	-	(typ.)	(typ.)	CS	RS	11125	
	0.1µF	0.1µF	100KΩ	2.2KΩ	15K Ω	100µH	0.1µF	0.068µF	2.2KΩ	T2300B,T2310B	

200V 200V

400V 400V

0.1µF 400V 100V Typical values for lamp dimming circuits

200V 100V

0.1µF

%W

1W

%W

1⁄2W

250KΩ 3.3KΩ



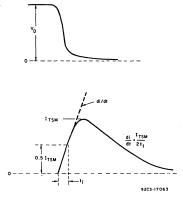
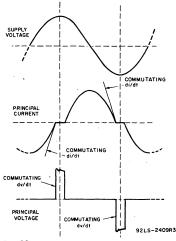


Fig. 19- Rate of change of on-state current with time (defining di/dt).



T2302B.T2312B

T2300D,T2302D

T2310D,T2312D

1⁄2W

.‰W

2.5KΩ

Fig. 20- Relationship between supply voltage and principle current (inductive load) showing reference points for definition of commutating voltage (dv/dt).